# **RF Transformer**

**TC2-1T** 

PRICE: Contact Sales Dept.

CASE STYLE: AT224

 $50\Omega$ 3 to 300 MHz

## **Maximum Ratings**

Operating Temperature	-20°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	0.25W
DC Current	30mA
Pormanant damage may easur if any o	f those limits are eveneded

### **Pin Connections**

PRIMARY DOT	6
PRIMARY	4
SECONDARY DOT	1
SECONDARY	3
SECONDARY CT	2

## **Features**

- · leadless surface mount
- good return loss
- excellent amplitude unbalance (0.5 dB typ)
- and phase unbalance (4 deg. typ) in 1 dB bandwidth
- aqueous washable

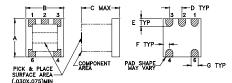
### **Applications**

- · impedance matching
- · balanced to unbalanced transformation
- push-pull amplifier

Ω	FREQUENCY		INSERTION LOSS*	
RATIO (Secondary/Primary)	(MHz)	3 dB MHz	2 dB MHz	1 dB MHz
2	3-300	_	_	3-300

**Transformer Electrical Specifications** 

## **Outline Drawing AT224**



### PCB Land Pattern



Suggested Layout, Tolerance to be within ±.002

**Typical Performance Data** 

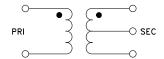
**NON-CATALOG** 

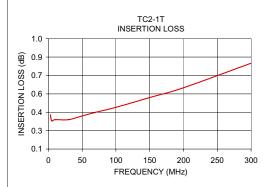
FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)	
3.00	0.38	21.63	
5.00	0.33	20.24	
10.00	0.34	19.32	
30.00	0.34	19.26	
50.00	0.37	19.41	
70.00	0.40	19.34	
100.00	0.44	19.00	
150.00	0.52	18.11	
200.00	0.60	17.06	
300.00	0.80	15.00	

## Outline Dimensions (inch)

Α	В	С	D	Е	F
.150	.150	.150	.050	.030	.025
3.81	3.81	3.81	1.27	0.76	0.64
G	Н	J	K		wt
.028	.065	.190	.030		grams
0.71	1.65	4.83	0.76		0.10

## Config. A









For detailed performance specs

<sup>\*</sup> Insertion Loss is referenced to mid-band loss, .4 dB typ.

**RF Transformer TC2-1T** 

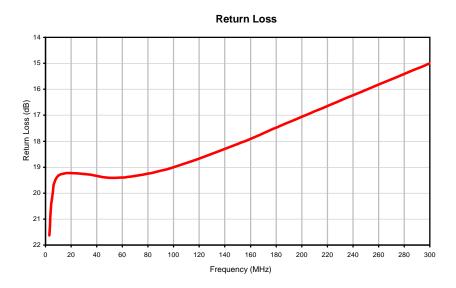
## Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
3.00	0.38	21.63
5.00	0.33	20.24
10.00	0.34	19.32
30.00	0.34	19.26
50.00	0.37	19.41
70.00	0.40	19.34
100.00	0.44	19.00
150.00	0.52	18.11
200.00	0.60	17.06
300.00	0.80	15.00

**RF Transformer** TC2-1T

## Typical Performance Curves

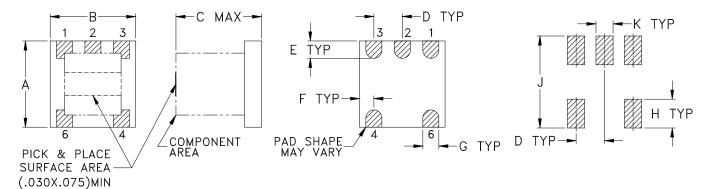




## **Outline Dimensions**

**AT224** 

## **PCB Land Pattern**



Suggested Layout, Tolerance to be within  $\pm .002$ 

CASE #	A	В	C	D	Е	F	G	Н	J	K	L	WT. GRAMS
AT224	.150 (3.81)	.150 (3.81)	.150 (3.81)	.050 (1.27)	.030 (0.76)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)		.10

Dimensions are in inches (mm). Tolerances: 2 Pl. ± .01; 3 Pl. ± .005

### **Notes:**

- Open style, ceramic base.
- Termination finish:

For RoHS Case Styles: 2-10  $\mu$  inch (.05-.25 microns) Gold over 100-300  $\mu$  inch (2.54-7.62 microns) Nickel plate. All models, (+) suffix.

For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.

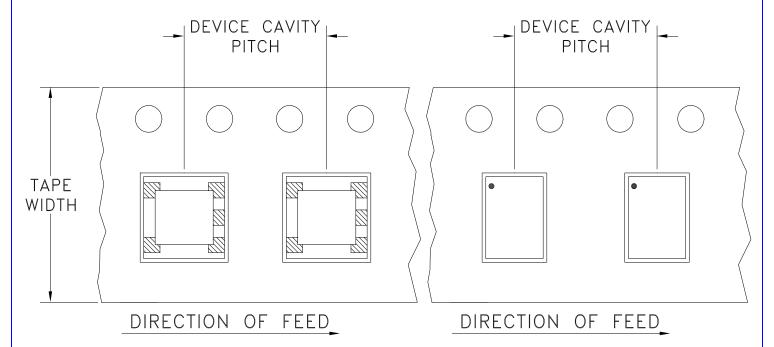




P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

# Tape & Reel Packaging TR-F17

## DEVICE ORIENTATION IN T&R



Tape Width,	<b>Device Cavity</b>	Reel Size,	Devices	s per Reel
mm	Pitch, mm	inches		
			Small	20
			quantity	50
		7	standards	100
12	8		(see note)	200
				500
		12	Ctondond	1000
		13	Standard	2000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf





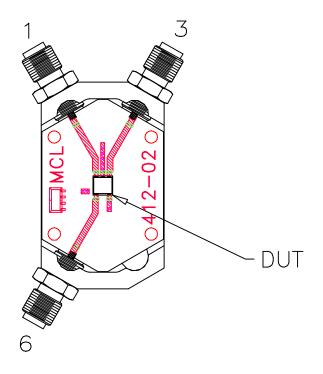
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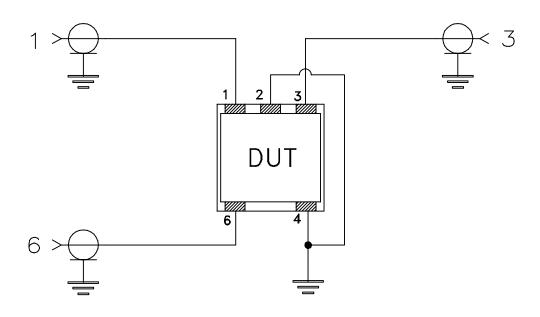
RFJIF MICROWAVE COMPONENTS

## **Evaluation Board and Circuit**

For Pin Connections refer to Data Sheet of the DUT



TB-145



Schematic Diagram

## Notes:

- 1. 50 Ohm SMA Female connectors.
- 2. PCB Material: Rogers RO4350B or its equivalent, III Mini-Circuits® Dielectric Constant=3.5, Thickness=.020"



## **Environmental Specifications**

ENV02

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-20° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215

ENV02 Rev: A

02/25/11

M130240 File: ENV02.pdf

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